

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Zener Diode

DE2S06800L

Panasonic

DE2S06800L

Silicon epitaxial planar type

For ESD protection

■ Features

- High ESD
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

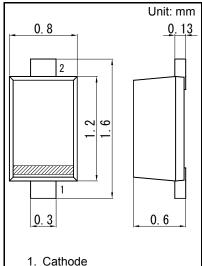
■ Marking Symbol: E2

■ Packaging

Embossed type (Thermo-compression sealing) 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C Parameter Symbol Rating Unit mWTotal power dissipation PT 150 Electrostatic discharge **ESD** ±30 kV Junction temperature Τį 150 °C Operating ambient temperature Topr -40 to +85 °C

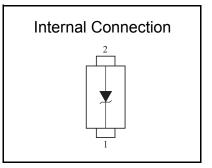
Storage temperature -55 to +150 Tstg Note) *1: Mounted on glass epoxy print board. (45 mm x 45 mm x 1 mm) Solder in (0.8 mm x 0.6 mm)



- 2. Anode

°C

Panasonic	SSMini2-F5-B		
JEITA	SC-79		
Code	SOD-523		



■ Electrical Characteristics Ta = 25 $^{\circ}$ C \pm 3 $^{\circ}$ C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Zener voltage *1,*2	VZ	IZ = 1 mA	6.46		7.14	V
Reverse current	IR	VR = 4 V			0.5	μA
Terminal capacitance	Ct	VR = 0 V, f = 1 MHz		50		pF
Temperature coefficient of zener voltage *3	SZ	IZ = 1 mA		3.0		mV/°C

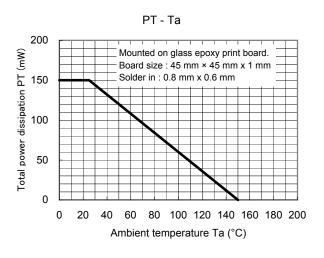
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
 - 2. *1: The temperature must be controlled 25°C for VZ mesurement. VZ value measured at other temperature must be adjusted to VZ (25°C)
 - *2: VZ guaranted 20 ms after current flow.
 - *3: Tj = 25°C to 150°C

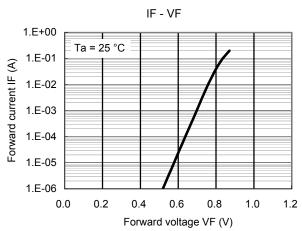
^{*2:} Test method:IEC61000_4_2(C = 150 pF,R = 330 Ω , Contact discharge:10 times)

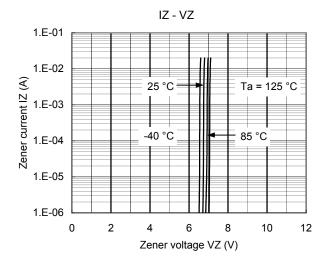
Zener Diode

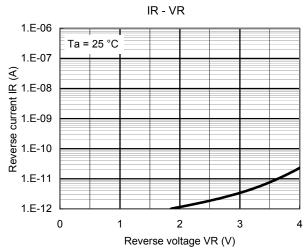
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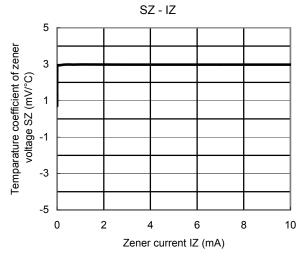
Technical Data (reference)

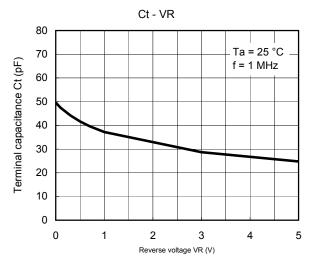












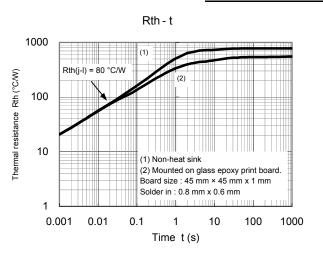
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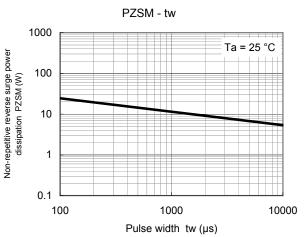
Panasonic

Zener Diode

DE2S06800L

Technical Data (reference)



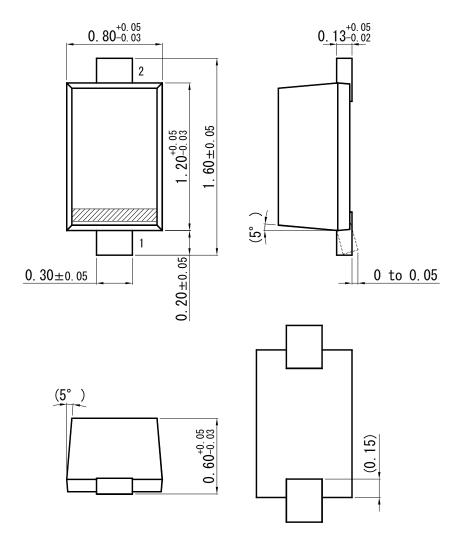


Zener Diode **Panasonic**

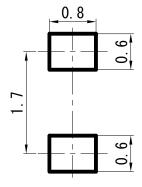
DE2S06800L

SSMini2-F5-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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